

# 74AHC74; 74AHCT74

Dual D-type flip-flop with set and reset; positive-edge trigger

Rev. 7 — 21 April 2015

Product data sheet

## 1. General description

The 74AHC74; 74AHCT74 is a high-speed Si-gate CMOS device and is pin compatible with Low-Power Schottky TTL (LSTTL). It is specified in compliance with JEDEC standard No. 7-A.

The 74AHC74; 74AHCT74 is a dual positive-edge triggered, D-type flip-flop with individual data inputs (D), clock inputs (CP), set inputs ( $\overline{SD}$ ) and reset inputs ( $\overline{RD}$ ). It also has complementary outputs (Q and  $\overline{Q}$ ).

The set and reset are asynchronous active LOW inputs that operate independent of the clock input. Information on the data input is transferred to the Q output on the LOW to HIGH transition of the clock pulse. The data inputs must be stable one set-up time prior to the LOW to HIGH clock transition for predictable operation.

Schmitt-trigger action in the clock input makes the circuit highly tolerant to slower clock rise and fall times.

## 2. Features and benefits

- Balanced propagation delays
- All inputs have Schmitt-trigger actions
- Inputs accept voltages higher than  $V_{CC}$
- Input levels:
  - ◆ For 74AHC74: CMOS level
  - ◆ For 74AHCT74: TTL level
- ESD protection:
  - ◆ HBM EIA/JESD22-A114E exceeds 2000 V
  - ◆ MM EIA/JESD22-A115-A exceeds 200 V
  - ◆ CDM EIA/JESD22-C101C exceeds 1000 V
- Multiple package options
- Specified from  $-40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$  and from  $-40\text{ }^{\circ}\text{C}$  to  $+125\text{ }^{\circ}\text{C}$



3. Ordering information

Table 1. Ordering information

| Type number     | Package           |          |  |          |
|-----------------|-------------------|----------|--|----------|
|                 | Temperature range | Name     | Description  | Version  |
| <b>74AHC74</b>  |                   |          |  |          |
| 74AHC74D        | −40 °C to +125 °C | SO14     | plastic small outline package; 14 leads; body width 3.9 mm   | SOT108-1 |
| 74AHC74PW       | −40 °C to +125 °C | TSSOP14  | plastic thin shrink small outline package; 14 leads; body width 4.4 mm   | SOT402-1 |
| 74AHC74BQ       | −40 °C to +125 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm | SOT762-1 |
| <b>74AHCT74</b> |                   |          |  |          |
| 74AHCT74D       | −40 °C to +125 °C | SO14     | plastic small outline package; 14 leads; body width 3.9 mm   | SOT108-1 |
| 74AHCT74PW      | −40 °C to +125 °C | TSSOP14  | plastic thin shrink small outline package; 14 leads; body width 4.4 mm   | SOT402-1 |
| 74AHCT74BQ      | −40 °C to +125 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm | SOT762-1 |

4. Functional diagram

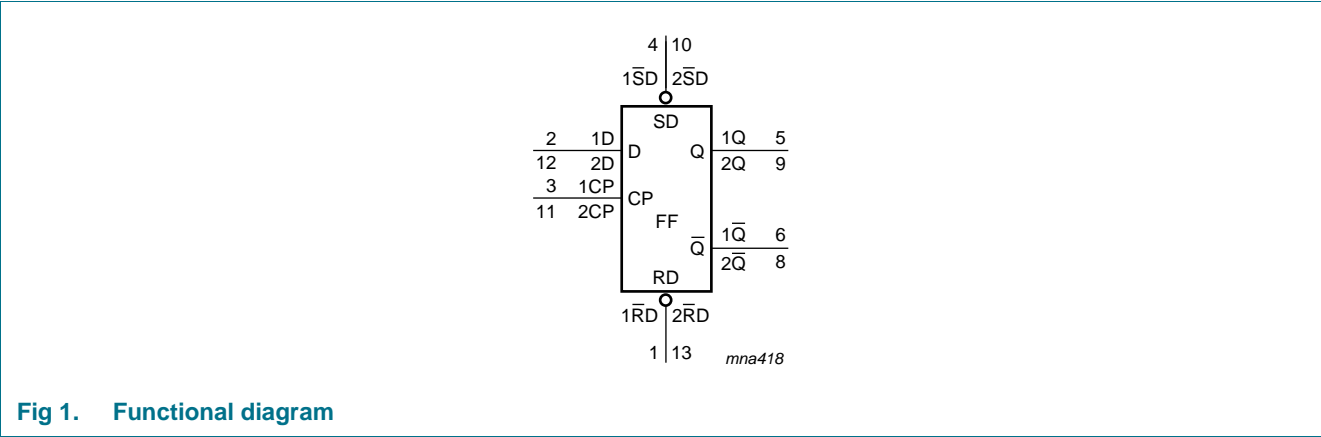
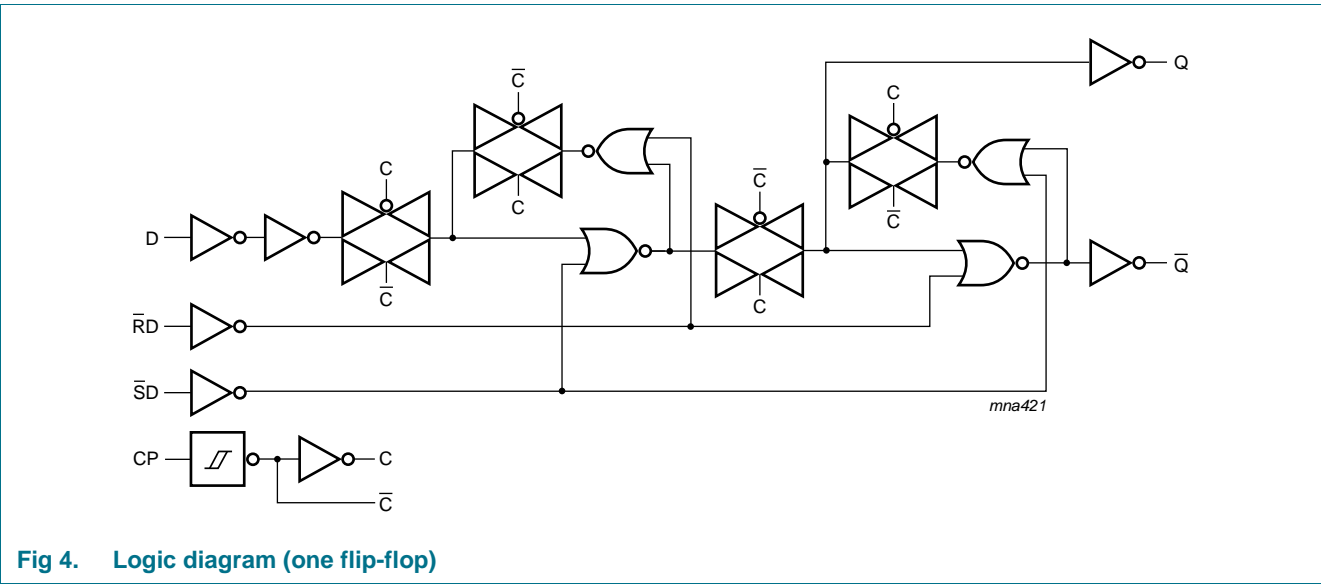
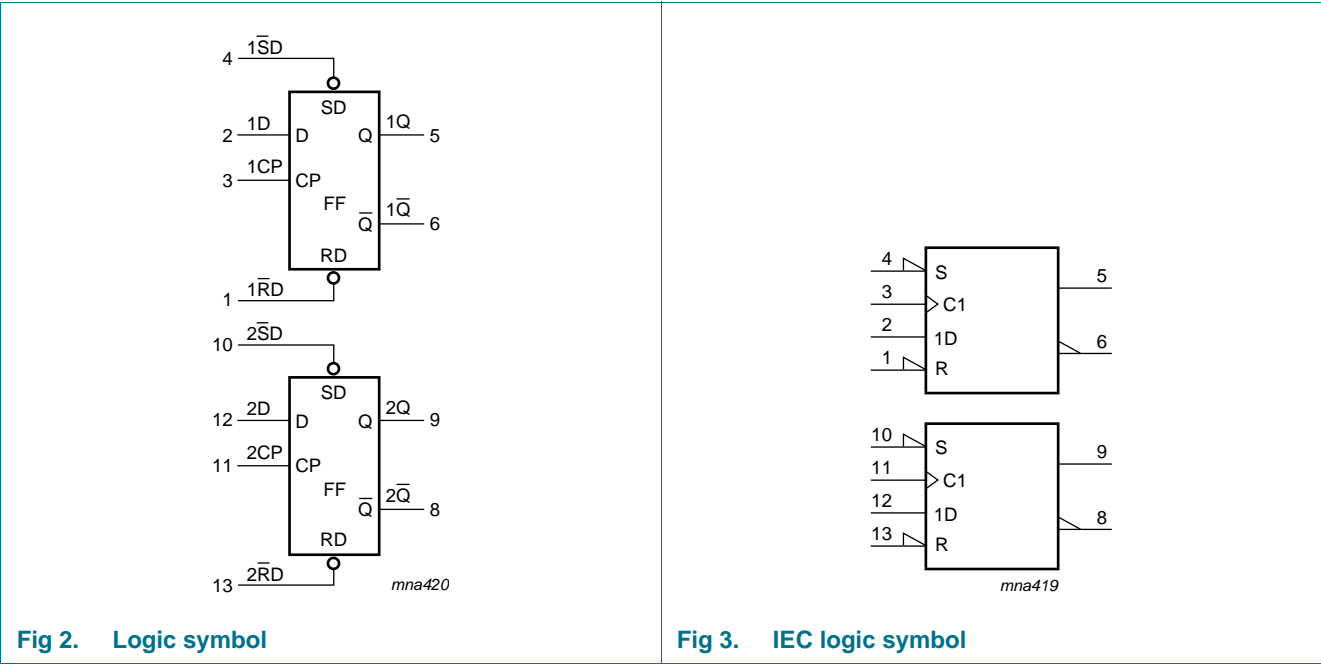


Fig 1. Functional diagram



## 5. Pinning information

### 5.1 Pinning

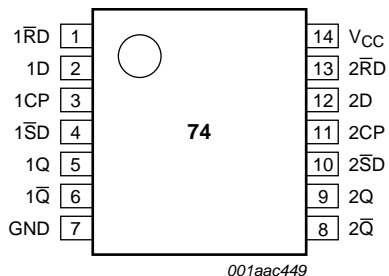


Fig 5. Pin configuration SO14 and TSSOP14

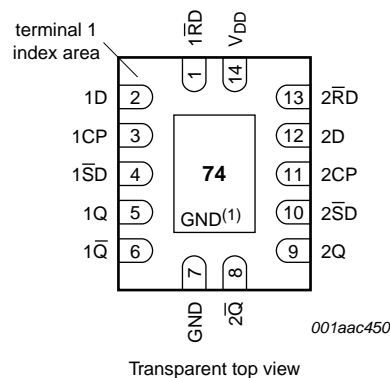


Fig 6. Pin configuration DHVQFN14

### 5.2 Pin description

Table 2. Pin description

| Symbol           | Pin | Description                                  |
|------------------|-----|--|
| $1\overline{RD}$ | 1   | asynchronous reset direct input (active LOW) |
| 1D               | 2   | data input                                   |
| 1CP              | 3   | clock input (LOW to HIGH, edge-triggered)    |
| $1\overline{SD}$ | 4   | asynchronous set direct input (active LOW)   |
| 1Q               | 5   | true flip-flop output                        |
| $1\overline{Q}$  | 6   | complement flip-flop output                  |
| GND              | 7   | ground (0 V)                                 |
| $2\overline{Q}$  | 8   | complement flip-flop output                  |
| 2Q               | 9   | true flip-flop output                        |
| $2\overline{SD}$ | 10  | asynchronous set direct input (active LOW)   |
| 2CP              | 11  | clock input (LOW to HIGH, edge-triggered)    |
| 2D               | 12  | data input                                   |
| $2\overline{RD}$ | 13  | asynchronous reset direct input (active LOW) |
| $V_{CC}$         | 14  | supply voltage                               |

## 6. Functional description

Table 3. Function table<sup>[1]</sup>

| Control          |                  |     | Input | Output |                 |            |                       |
|------------------|------------------|-----|-------|--------|-----------------|------------|-----------------------|
| $\overline{nSD}$ | $\overline{nRD}$ | nCP | nD    | nQ     | $\overline{nQ}$ | $nQ_{n+1}$ | $\overline{nQ}_{n+1}$ |
| L                | H                | X   | X     | H      | L               | -          | -                     |
| H                | L                | X   | X     | L      | H               | -          | -                     |
| L                | L                | X   | X     | H      | H               | -          | -                     |
| H                | H                | ↑   | L     | -      | -               | L          | H                     |
| H                | H                | ↑   | H     | -      | -               | H          | L                     |

- [1] H = HIGH voltage level;  
 L = LOW voltage level;  
 ↑ = LOW to HIGH transition;  
 $Q_{n+1}$  = state after the next LOW to HIGH CP transition;  
 X = don't care.

## 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol    | Parameter               | Conditions  | Min  | Max  | Unit |
|-----------|-------------------------|---|------|------|------|
| $V_{CC}$  | supply voltage          |   | -0.5 | +7.0 | V    |
| $V_I$     | input voltage           |   | -0.5 | +7.0 | V    |
| $I_{IK}$  | input clamping current  | $V_I < -0.5$ V <sup>[1]</sup>                           | -20  | -    | mA   |
| $I_{OK}$  | output clamping current | $V_O < -0.5$ V or $V_O > V_{CC} + 0.5$ V <sup>[1]</sup> | -20  | +20  | mA   |
| $I_O$     | output current          | $V_O = -0.5$ V to $(V_{CC} + 0.5)$ V                    | -25  | +25  | mA   |
| $I_{CC}$  | supply current          |   | -    | +75  | mA   |
| $I_{GND}$ | ground current          |   | -75  | -    | mA   |
| $T_{stg}$ | storage temperature     |   | -65  | +150 | °C   |
| $P_{tot}$ | total power dissipation | $T_{amb} = -40$ °C to +125 °C <sup>[2]</sup>            | -    | 500  | mW   |

- [1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
 [2] For SO14 packages: above 70 °C the value of  $P_{tot}$  derates linearly at 8 mW/K.  
 For TSSOP14 packages: above 60 °C the value of  $P_{tot}$  derates linearly at 5.5 mW/K.  
 For DHVQFN14 packages: above 60 °C the value of  $P_{tot}$  derates linearly at 4.5 mW/K.

## 8. Recommended operating conditions

Table 5. Operating conditions

| Symbol           | Parameter                           | Conditions                       | Min | Typ | Max             | Unit |
|------------------|-------------------------------------|----------------------------------|-----|-----|-----------------|------|
| 74AHC74          |                                     |                                  |     |     |                 |      |
| V <sub>CC</sub>  | supply voltage                      |                                  | 2.0 | 5.0 | 5.5             | V    |
| V <sub>I</sub>   | input voltage                       |                                  | 0   | -   | 5.5             | V    |
| V <sub>O</sub>   | output voltage                      |                                  | 0   | -   | V <sub>CC</sub> | V    |
| T <sub>amb</sub> | ambient temperature                 |                                  | −40 | +25 | +125            | °C   |
| Δt/ΔV            | input transition rise and fall rate | V <sub>CC</sub> = 3.0 V to 3.6 V | -   | -   | 100             | ns/V |
|                  |                                     | V <sub>CC</sub> = 4.5 V to 5.5 V | -   | -   | 20              | ns/V |
| 74AHCT74         |                                     |                                  |     |     |                 |      |
| V <sub>CC</sub>  | supply voltage                      |                                  | 4.5 | 5.0 | 5.5             | V    |
| V <sub>I</sub>   | input voltage                       |                                  | 0   | -   | 5.5             | V    |
| V <sub>O</sub>   | output voltage                      |                                  | 0   | -   | V <sub>CC</sub> | V    |
| T <sub>amb</sub> | ambient temperature                 |                                  | −40 | +25 | +125            | °C   |
| Δt/ΔV            | input transition rise and fall rate | V <sub>CC</sub> = 4.5 V to 5.5 V | -   | -   | 20              | ns/V |

## 9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter                 | Conditions  | 25 °C |     |      | −40 °C to +85 °C |      | −40 °C to +125 °C |      | Unit |
|-----------------|---------------------------|---|-------|-----|------|------------------|------|-------------------|------|------|
|                 |                           |   | Min   | Typ | Max  | Min              | Max  | Min               | Max  |      |
| 74AHC74         |                           |   |       |     |      |                  |      |                   |      |      |
| V <sub>IH</sub> | HIGH-level input voltage  | V <sub>CC</sub> = 2.0 V                             | 1.5   | -   | -    | 1.5              | -    | 1.5               | -    | V    |
|                 |                           | V <sub>CC</sub> = 3.0 V                             | 2.1   | -   | -    | 2.1              | -    | 2.1               | -    | V    |
|                 |                           | V <sub>CC</sub> = 5.5 V                             | 3.85  | -   | -    | 3.85             | -    | 3.85              | -    | V    |
| V <sub>IL</sub> | LOW-level input voltage   | V <sub>CC</sub> = 2.0 V                             | -     | -   | 0.5  | -                | 0.5  | -                 | 0.5  | V    |
|                 |                           | V <sub>CC</sub> = 3.0 V                             | -     | -   | 0.9  | -                | 0.9  | -                 | 0.9  | V    |
|                 |                           | V <sub>CC</sub> = 5.5 V                             | -     | -   | 1.65 | -                | 1.65 | -                 | 1.65 | V    |
| V <sub>OH</sub> | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> |       |     |      |                  |      |                   |      |      |
|                 |                           | I <sub>O</sub> = −50 μA; V <sub>CC</sub> = 2.0 V    | 1.9   | 2.0 | -    | 1.9              | -    | 1.9               | -    | V    |
|                 |                           | I <sub>O</sub> = −50 μA; V <sub>CC</sub> = 3.0 V    | 2.9   | 3.0 | -    | 2.9              | -    | 2.9               | -    | V    |
|                 |                           | I <sub>O</sub> = −50 μA; V <sub>CC</sub> = 4.5 V    | 4.4   | 4.5 | -    | 4.4              | -    | 4.4               | -    | V    |
|                 |                           | I <sub>O</sub> = −4.0 mA; V <sub>CC</sub> = 3.0 V   | 2.58  | -   | -    | 2.48             | -    | 2.40              | -    | V    |
| V <sub>OL</sub> | LOW-level output voltage  | I <sub>O</sub> = −8.0 mA; V <sub>CC</sub> = 4.5 V   | 3.94  | -   | -    | 3.80             | -    | 3.70              | -    | V    |
|                 |                           | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> |       |     |      |                  |      |                   |      |      |
|                 |                           | I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 2.0 V     | -     | 0   | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|                 |                           | I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 3.0 V     | -     | 0   | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|                 |                           | I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 4.5 V     | -     | 0   | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|                 |                           | I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V    | -     | -   | 0.36 | -                | 0.44 | -                 | 0.55 | V    |
|                 |                           | I <sub>O</sub> = 8.0 mA; V <sub>CC</sub> = 4.5 V    | -     | -   | 0.36 | -                | 0.44 | -                 | 0.55 | V    |

**Table 6.** Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter                 | Conditions  | 25 °C |     |      | –40 °C to +85 °C |      | –40 °C to +125 °C |      | Unit          |
|-----------------|---------------------------|---|-------|-----|------|------------------|------|-------------------|------|---------------|
|                 |                           |   | Min   | Typ | Max  | Min              | Max  | Min               | Max  |               |
| $I_I$           | input leakage current     | $V_I = 5.5 \text{ V}$ or GND;<br>$V_{CC} = 0 \text{ V}$ to 5.5 V  | -     | -   | 0.1  | -                | 1.0  | -                 | 2.0  | $\mu\text{A}$ |
| $I_{CC}$        | supply current            | $V_I = V_{CC}$ or GND; $I_O = 0 \text{ A}$ ;<br>$V_{CC} = 5.5 \text{ V}$  | -     | -   | 2.0  | -                | 20   | -                 | 40   | $\mu\text{A}$ |
| $C_I$           | input capacitance         | $V_I = V_{CC}$ or GND   | -     | 3   | 10   | -                | 10   | -                 | 10   | pF            |
| <b>74AHCT74</b> |                           |   |       |     |      |                  |      |                   |      |               |
| $V_{IH}$        | HIGH-level input voltage  | $V_{CC} = 4.5 \text{ V}$ to 5.5 V   | 2.0   | -   | -    | 2.0              | -    | 2.0               | -    | V             |
| $V_{IL}$        | LOW-level input voltage   | $V_{CC} = 4.5 \text{ V}$ to 5.5 V   | -     | -   | 0.8  | -                | 0.8  | -                 | 0.8  | V             |
| $V_{OH}$        | HIGH-level output voltage | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$<br>$I_O = -50 \mu\text{A}$  | 4.4   | 4.5 | -    | 4.4              | -    | 4.4               | -    | V             |
|                 |                           | $I_O = -8.0 \text{ mA}$   | 3.94  | -   | -    | 3.80             | -    | 3.70              | -    | V             |
|                 |                           |   |       |     |      |                  |      |                   |      |               |
| $V_{OL}$        | LOW-level output voltage  | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$<br>$I_O = 50 \mu\text{A}$   | -     | 0   | 0.1  | -                | 0.1  | -                 | 0.1  | V             |
|                 |                           | $I_O = 8.0 \text{ mA}$  | -     | -   | 0.36 | -                | 0.44 | -                 | 0.55 | V             |
|                 |                           |   |       |     |      |                  |      |                   |      |               |
| $I_I$           | input leakage current     | $V_I = 5.5 \text{ V}$ or GND;<br>$V_{CC} = 0 \text{ V}$ to 5.5 V  | -     | -   | 0.1  | -                | 1.0  | -                 | 2.0  | $\mu\text{A}$ |
| $I_{CC}$        | supply current            | $V_I = V_{CC}$ or GND; $I_O = 0 \text{ A}$ ;<br>$V_{CC} = 5.5 \text{ V}$  | -     | -   | 2.0  | -                | 20   | -                 | 40   | $\mu\text{A}$ |
| $\Delta I_{CC}$ | additional supply current | per input pin;<br>$V_I = V_{CC} - 2.1 \text{ V}$ ; other pins<br>at $V_{CC}$ or GND; $I_O = 0 \text{ A}$ ;<br>$V_{CC} = 4.5 \text{ V}$ to 5.5 V | -     | -   | 1.35 | -                | 1.5  | -                 | 1.5  | mA            |
| $C_I$           | input capacitance         | $V_I = V_{CC}$ or GND   | -     | 3   | 10   | -                | 10   | -                 | 10   | pF            |

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V); for test circuit, see [Figure 9](#).

| Symbol           | Parameter         | Conditions   | 25 °C |                    |      | –40 °C to +85 °C |      | –40 °C to +125 °C |      | Unit |
|------------------|-------------------|--|-------|--------------------|------|------------------|------|-------------------|------|------|
|                  |                   |  | Min   | Typ <sup>[1]</sup> | Max  | Min              | Max  | Min               | Max  |      |
| 74AHC74          |                   |  |       |                    |      |                  |      |                   |      |      |
| t <sub>pd</sub>  | propagation delay | nCP to nQ, nQ̄; see <a href="#">Figure 7</a> <sup>[2]</sup>                              |       |                    |      |                  |      |                   |      |      |
|                  |                   | V <sub>CC</sub> = 3.0 V to 3.6 V   |       |                    |      |                  |      |                   |      |      |
|                  |                   | C <sub>L</sub> = 15 pF   | -     | 5.2                | 11.9 | 1.0              | 14.0 | 1.0               | 15.0 | ns   |
|                  |                   | C <sub>L</sub> = 50 pF   | -     | 7.4                | 15.4 | 1.0              | 17.5 | 1.0               | 19.5 | ns   |
|                  |                   | V <sub>CC</sub> = 4.5 V to 5.5 V   |       |                    |      |                  |      |                   |      |      |
|                  |                   | C <sub>L</sub> = 15 pF   | -     | 3.7                | 7.3  | 1.0              | 8.5  | 1.0               | 9.5  | ns   |
|                  |                   | C <sub>L</sub> = 50 pF   | -     | 5.2                | 9.3  | 1.0              | 10.5 | 1.0               | 12.0 | ns   |
|                  |                   | nSD̄, nRD̄ to nQ, nQ̄;<br>see <a href="#">Figure 8</a>                                   |       |                    |      |                  |      |                   |      |      |
|                  |                   | V <sub>CC</sub> = 3.0 V to 3.6 V   |       |                    |      |                  |      |                   |      |      |
|                  |                   | C <sub>L</sub> = 15 pF   | -     | 5.4                | 12.3 | 1.0              | 14.5 | 1.0               | 15.5 | ns   |
|                  |                   | C <sub>L</sub> = 50 pF   | -     | 7.7                | 15.8 | 1.0              | 18.0 | 1.0               | 20.0 | ns   |
|                  |                   | V <sub>CC</sub> = 4.5 V to 5.5 V   |       |                    |      |                  |      |                   |      |      |
|                  |                   | C <sub>L</sub> = 15 pF   | -     | 3.7                | 7.7  | 1.0              | 9.0  | 1.0               | 10.0 | ns   |
|                  |                   | C <sub>L</sub> = 50 pF   | -     | 5.3                | 9.7  | 1.0              | 11.0 | 1.0               | 12.5 | ns   |
| f <sub>max</sub> | maximum frequency | see <a href="#">Figure 7</a>   |       |                    |      |                  |      |                   |      |      |
|                  |                   | V <sub>CC</sub> = 3.0 V to 3.6 V   |       |                    |      |                  |      |                   |      |      |
|                  |                   | C <sub>L</sub> = 15 pF   | 80    | 125                | -    | 70               | -    | 70                | -    | MHz  |
|                  |                   | C <sub>L</sub> = 50 pF   | 50    | 75                 | -    | 45               | -    | 45                | -    | MHz  |
|                  |                   | V <sub>CC</sub> = 4.5 V to 5.5 V   |       |                    |      |                  |      |                   |      |      |
|                  |                   | C <sub>L</sub> = 15 pF   | 130   | 170                | -    | 110              | -    | 110               | -    | MHz  |
|                  |                   | C <sub>L</sub> = 50 pF   | 90    | 115                | -    | 75               | -    | 75                | -    | MHz  |
| t <sub>W</sub>   | pulse width       | CP HIGH or LOW;<br>nSD̄, nRD̄ LOW;<br>see <a href="#">Figure 7</a> and <a href="#">8</a> |       |                    |      |                  |      |                   |      |      |
|                  |                   | V <sub>CC</sub> = 3.0 V to 3.6 V   | 6.0   | -                  | -    | 7.0              | -    | 7.0               | -    | ns   |
|                  |                   | V <sub>CC</sub> = 4.5 V to 5.5 V   | 5.0   | -                  | -    | 5.0              | -    | 5.0               | -    | ns   |
| t <sub>su</sub>  | set-up time       | nD to nCP; see <a href="#">Figure 7</a>  |       |                    |      |                  |      |                   |      |      |
|                  |                   | V <sub>CC</sub> = 3.0 V to 3.6 V   | 6.0   | -                  | -    | 7.0              | -    | 7.0               | -    | ns   |
|                  |                   | V <sub>CC</sub> = 4.5 V to 5.5 V   | 5.0   | -                  | -    | 5.0              | -    | 5.0               | -    | ns   |
| t <sub>h</sub>   | hold time         | nD to nCP; see <a href="#">Figure 7</a>  |       |                    |      |                  |      |                   |      |      |
|                  |                   | V <sub>CC</sub> = 3.0 V to 3.6 V   | 0.5   | -                  | -    | 0.5              | -    | 0.5               | -    | ns   |
|                  |                   | V <sub>CC</sub> = 4.5 V to 5.5 V   | 0.5   | -                  | -    | 0.5              | -    | 0.5               | -    | ns   |
| t <sub>rec</sub> | recovery time     | nRD to nCP; see <a href="#">Figure 8</a>   |       |                    |      |                  |      |                   |      |      |
|                  |                   | V <sub>CC</sub> = 3.0 V to 3.6 V   | 5.0   | -                  | -    | 5.0              | -    | 5.0               | -    | ns   |
|                  |                   | V <sub>CC</sub> = 4.5 V to 5.5 V   | 3.0   | -                  | -    | 3.0              | -    | 3.0               | -    | ns   |

**Table 7. Dynamic characteristics ...continued**

Voltages are referenced to GND (ground = 0 V); for test circuit, see [Figure 9](#).

| Symbol   | Parameter                     | Conditions   | 25 °C |                    |      | –40 °C to +85 °C |      | –40 °C to +125 °C |      | Unit |
|--|-------------------------------|--|-------|--------------------|------|------------------|------|-------------------|------|------|
|  |                               |  | Min   | Typ <sup>[1]</sup> | Max  | Min              | Max  | Min               | Max  |      |
| C <sub>PD</sub>                                  | power dissipation capacitance | f <sub>i</sub> = 1 MHz; V <sub>I</sub> = GND to V <sub>CC</sub> <a href="#">[3]</a>    | -     | 12                 | -    | -                | -    | -                 | -    | pF   |
| <b>74AHCT74; V<sub>CC</sub> = 4.5 V to 5.5 V</b> |                               |  |       |                    |      |                  |      |                   |      |      |
| t <sub>pd</sub>                                  | propagation delay             | nCP to nQ, nQ̄; see <a href="#">Figure 7</a> <a href="#">[2]</a>                       |       |                    |      |                  |      |                   |      |      |
|  |                               | C <sub>L</sub> = 15 pF   | -     | 3.3                | 7.8  | 1.0              | 9.0  | 1.0               | 10.0 | ns   |
|  |                               | C <sub>L</sub> = 50 pF   | -     | 4.8                | 8.8  | 1.0              | 10.0 | 1.0               | 11.0 | ns   |
|  |                               | nSD, nRD to nQ, nQ̄;<br>see <a href="#">Figure 7</a>                                   |       |                    |      |                  |      |                   |      |      |
|  |                               | C <sub>L</sub> = 15 pF   | -     | 3.7                | 10.4 | 1.0              | 12.0 | 1.0               | 13.0 | ns   |
|  |                               | C <sub>L</sub> = 50 pF   | -     | 5.3                | 11.4 | 1.0              | 13.0 | 1.0               | 14.5 | ns   |
| f <sub>max</sub>                                 | maximum frequency             | see <a href="#">Figure 7</a>   |       |                    |      |                  |      |                   |      |      |
|  |                               | C <sub>L</sub> = 15 pF   | 100   | 160                | -    | 80               | -    | 80                | -    | MHz  |
|  |                               | C <sub>L</sub> = 50 pF   | 80    | 140                | -    | 65               | -    | 65                | -    | MHz  |
| t <sub>W</sub>                                   | pulse width                   | CP HIGH or LOW;<br>nSD, nRD LOW;<br>see <a href="#">Figure 7</a> and <a href="#">8</a> | 5.0   | -                  | -    | 5.0              | -    | 5.0               | -    | ns   |
| t <sub>su</sub>                                  | set-up time                   | nD to nCP; see <a href="#">Figure 7</a>  | 5.0   | -                  | -    | 5.0              | -    | 5.0               | -    | ns   |
| t <sub>h</sub>                                   | hold time                     | nD to nCP; see <a href="#">Figure 7</a>  | 0     | -                  | -    | 0                | -    | 0                 | -    | ns   |
| t <sub>rec</sub>                                 | recovery time                 | nRD to nCP; see <a href="#">Figure 8</a>   | 3.5   | -                  | -    | 3.5              | -    | 3.5               | -    | ns   |
| C <sub>PD</sub>                                  | power dissipation capacitance | f <sub>i</sub> = 1 MHz; V <sub>I</sub> = GND to V <sub>CC</sub> <a href="#">[3]</a>    | -     | 16                 | -    | -                | -    | -                 | -    | pF   |

[1] Typical values are measured at nominal supply voltage (V<sub>CC</sub> = 3.3 V and V<sub>CC</sub> = 5.0 V).

[2] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.

[3] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f<sub>i</sub> = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

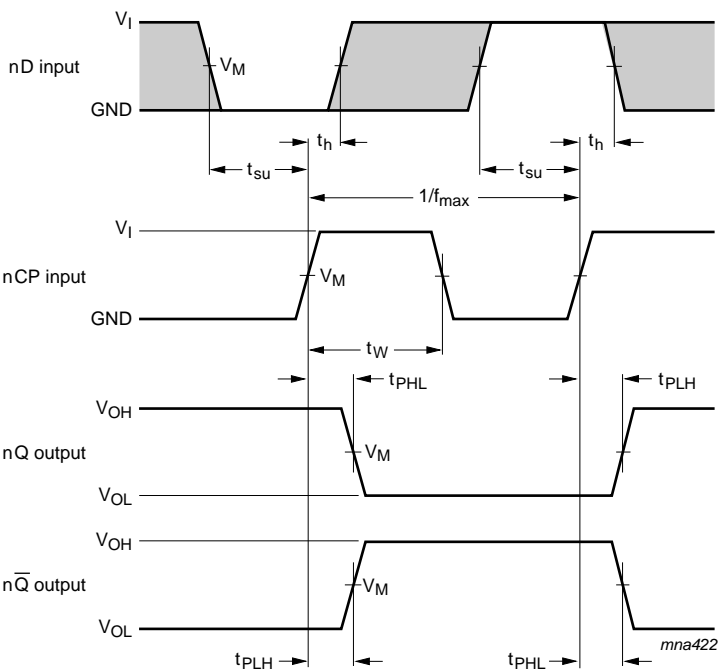
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

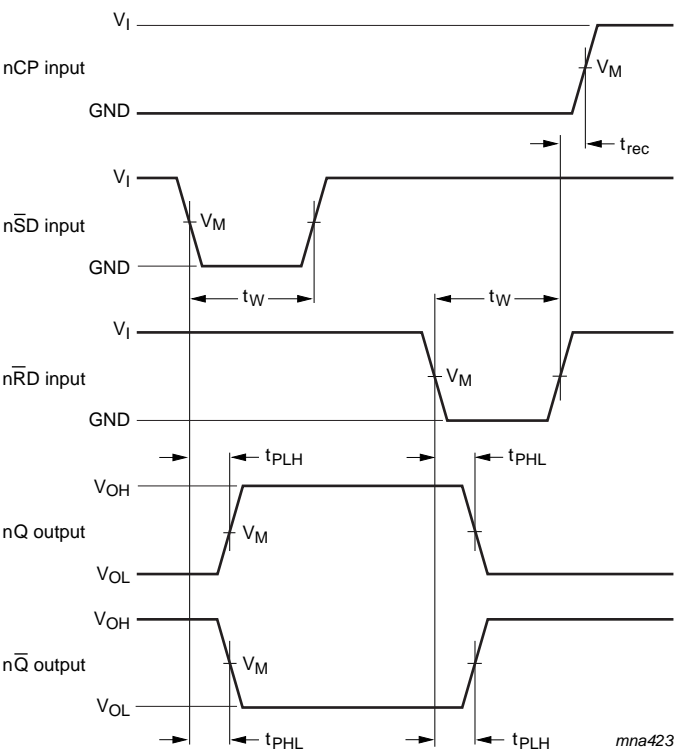
Σ(C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) = sum of the outputs.

11. Waveforms



Measurement points are given in [Table 8](#).  
The shaded areas indicate when the input is permitted to change for predictable output performance.  
V<sub>OL</sub> and V<sub>OH</sub> are typical voltage output levels that occur with the output load.

**Fig 7. Clock pulse width, maximum frequency, set-up times, hold times and input to output propagation delays**

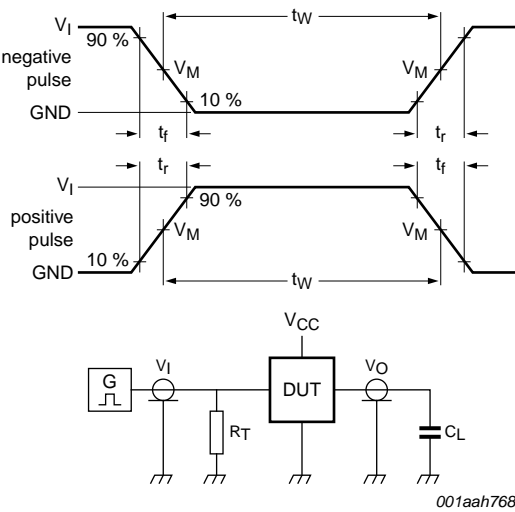


Measurement points are given in [Table 8](#).  
 $V_{OL}$  and  $V_{OH}$  are typical voltage output levels that occur with the output load.

**Fig 8. Set and reset pulse widths, recovery time and input to output propagation delays**

**Table 8. Measurement points**

| Type     | Input               | Output              |
|----------|---------------------|---------------------|
|          | $V_M$               | $V_M$               |
| 74AHC74  | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |
| 74AHCT74 | 1.5 V               | $0.5 \times V_{CC}$ |



For test data, see [Table 9](#).

Definitions for test circuit:

$C_L$  = Load capacitance including jig and probe capacitance.

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

**Fig 9. Load circuitry for switching times**

**Table 9. Test data**

| Type     | Input    |               | Load         | Test               |
|----------|----------|---------------|--------------|--------------------|
|          | $V_I$    | $t_r, t_f$    | $C_L$        |                    |
| 74AHC74  | $V_{CC}$ | $\leq 3.0$ ns | 50 pF, 15 pF | $t_{PLH}, t_{PHL}$ |
| 74AHCT74 | 3.0 V    | $\leq 3.0$ ns | 50 pF, 15 pF | $t_{PLH}, t_{PHL}$ |

12. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mmSOT108-1

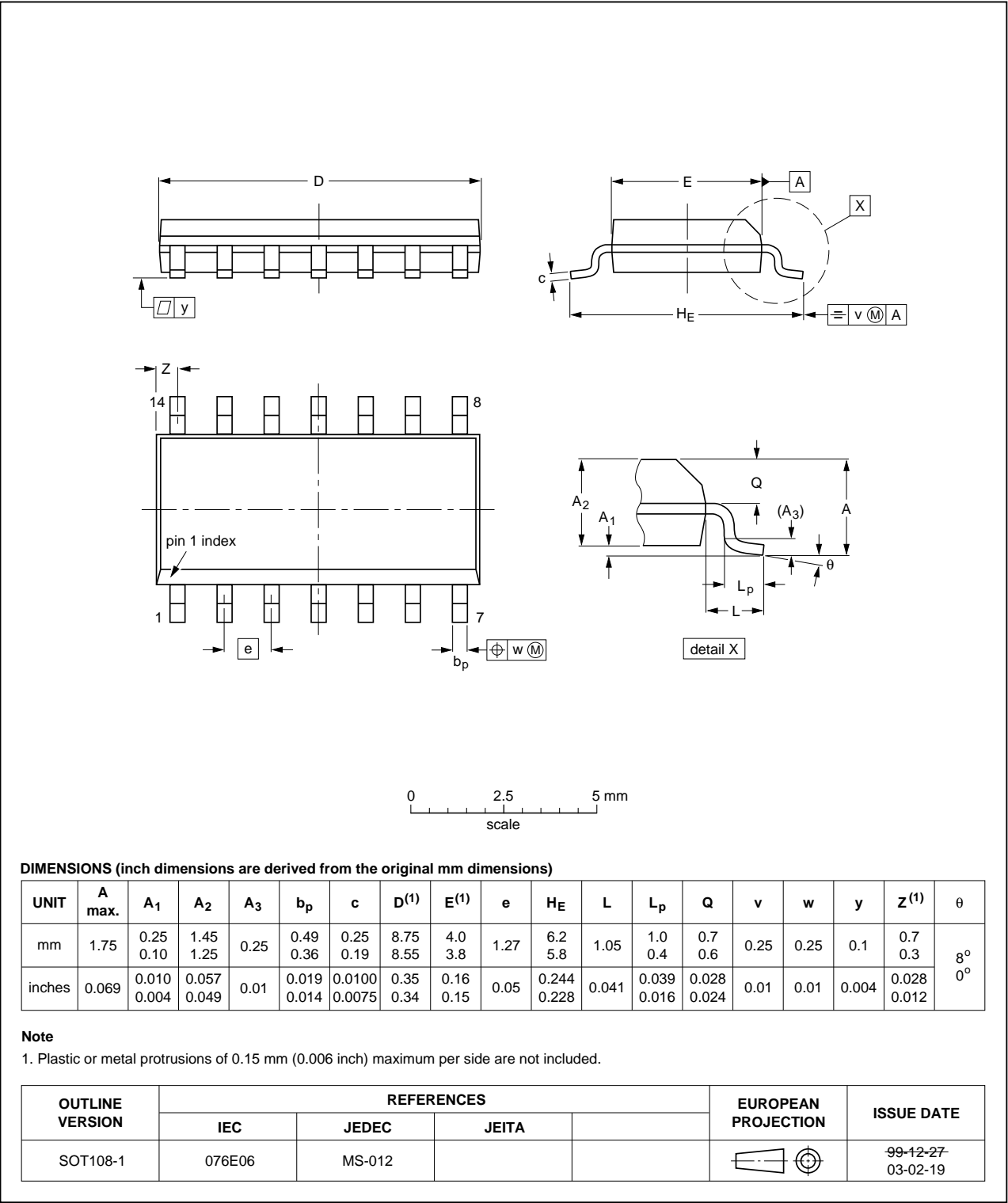


Fig 10. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

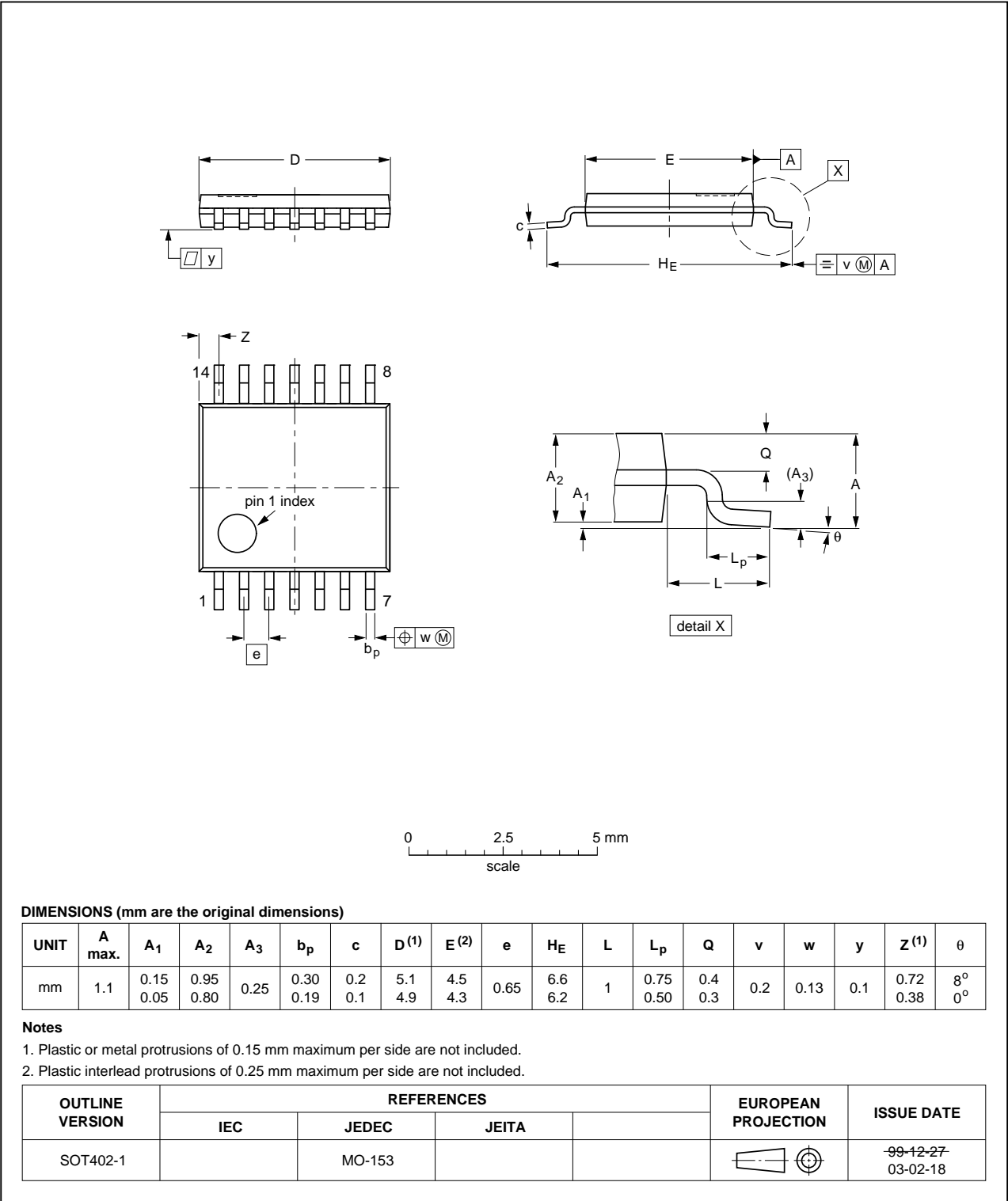


Fig 11. Package outline SOT402-1 (TSSOP14)

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads;  
14 terminals; body 2.5 x 3 x 0.85 mm

SOT762-1

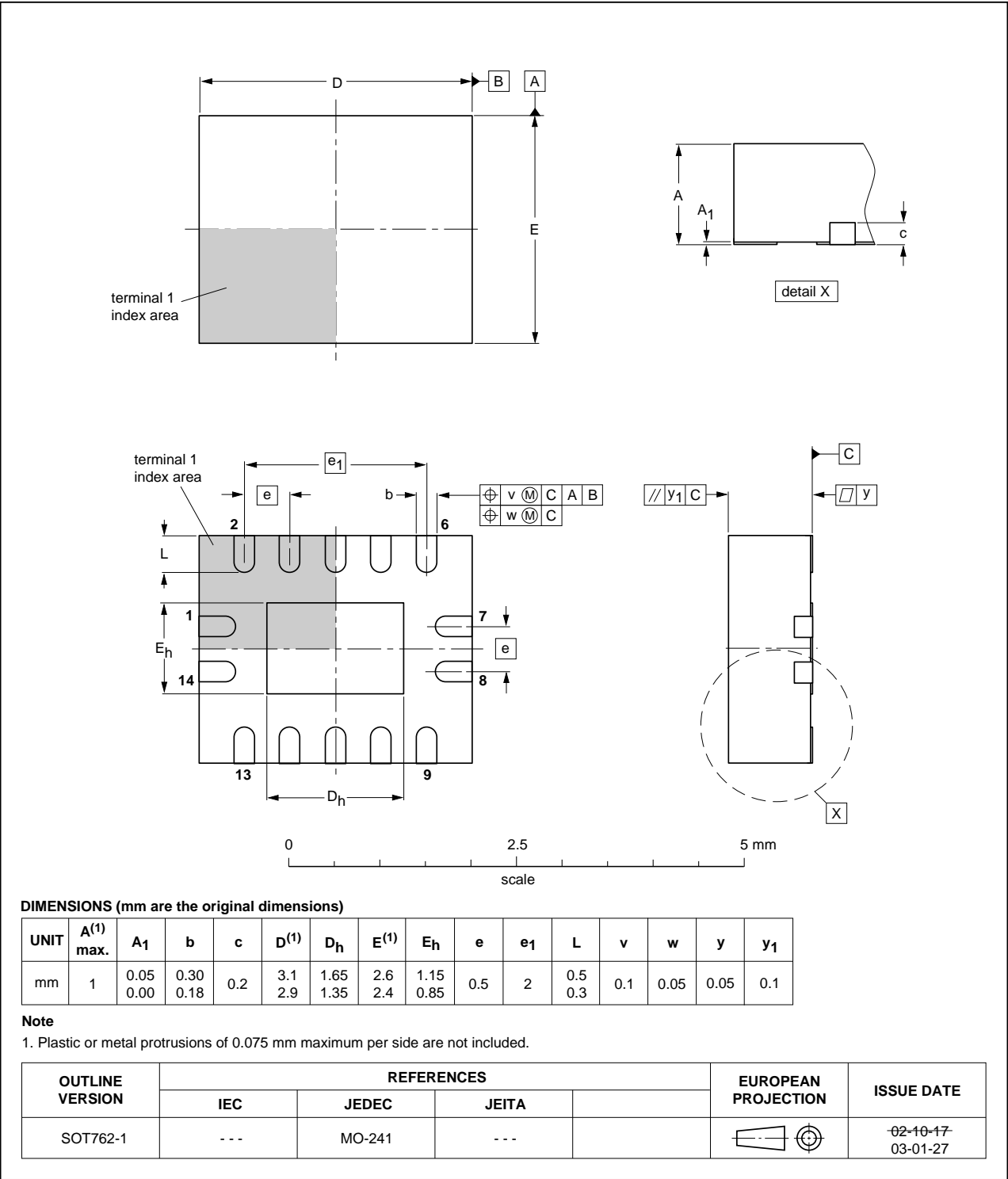


Fig 12. Package outline SOT762-1 (DHVQFN14)

## 13. Abbreviations

Table 10. Abbreviations

| Acronym | Description                                    |
|---------|--|
| CDM     | Charged Device Model                           |
| CMOS    | Complementary Metal-Oxide Semiconductor        |
| ESD     | ElectroStatic Discharge                        |
| HBM     | Human Body Model                               |
| LSTTL   | Low-power Schottky Transistor-Transistor Logic |
| MM      | Machine Model                                  |

## 14. Revision history

Table 11. Revision history

| Document ID      | Release date  | Data sheet status     | Change notice | Supersedes       |
|------------------|---|-----------------------|---------------|------------------|
| 74AHC_AHCT74 v.7 | 20150421  | Product data sheet    | -             | 74AHC_AHCT74 v.6 |
| Modifications:   | <ul style="list-style-type: none"> <li><a href="#">Table 7</a>: minimum <math>f_{max}</math> values at 3.0 V to 3.6 V for 74AHC74 corrected (errata).</li> </ul>  |                       |               |                  |
| 74AHC_AHCT74 v.6 | 20141020  | Product data sheet    | -             | 74AHC_AHCT74 v.5 |
| Modifications:   | <ul style="list-style-type: none"> <li><a href="#">Table 3</a> corrected (errata).</li> </ul>   |                       |               |                  |
| 74AHC_AHCT74 v.5 | 20080609  | Product data sheet    | -             | 74AHC_AHCT74 v.4 |
| Modifications:   | <ul style="list-style-type: none"> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Table 6: the conditions for input leakage current have been changed.</li> </ul> |                       |               |                  |
| 74AHC_AHCT74 v.4 | 20050207  | Product data sheet    | -             | 74AHC_AHCT74 v.3 |
| 74AHC_AHCT74 v.3 | 20040429  | Product specification | -             | 74AHC_AHCT74 v.2 |
| 74AHC_AHCT74 v.2 | 19990923  | Product specification | -             | 74AHC_AHCT74 v.1 |
| 74AHC_AHCT74 v.1 | 19990805  | Product specification | -             | -                |

## 15. Legal information

### 15.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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